507617792 11/28/2022

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT7664685

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
EIJI TSUKADA	11/10/2022
MASAHIDE TSUKADA	11/10/2022

RECEIVING PARTY DATA

Name:	TECSIA MACHINERY CORPORATION	
Street Address:	7-23-15, OHIZUMIGAKUEN-MACHI, NERIMA-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	178-0061	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	18070232

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	743065-471	
NAME OF SUBMITTER:	THOMAS W. COLE	
SIGNATURE:	/Thomas W. Cole/	
DATE SIGNED:	11/28/2022	

Total Attachments: 1

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PATENT REEL: 061895 FRAME: 0076 507617792

ASSIGNMENT

WHEREAS, Eiji TSUKADA and Masahide TSUKADA (hereinafter referred to as ASSIGNOR(S)), has/have invented certain new and useful invention(s) relating to SHEET FEED SHAFT, MANUFACTURING DEVICE FOR THE SAME, AND METHOD FOR MANUFACTURING THE SAME (hereinafter referred to as THE INVENTION) for which a U.S. patent application No. 18070232 was filed on November 28, 2022

WHEREAS, TECSIA MACHINERY CORPORATION, a corporation duly organized under and pursuant to the laws of Japan and whose post office address is 7-23-15, Ohizumigakuen-machi, Nerima-ku, Tokyo 178-0061, Japan (hereinafter referred to as ASSIGNEE(S)), is/are desirous of acquiring the entire right, title and interest in and to THE INVENTION in the United States and throughout the world.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, ASSIGNOR(S), by these presents does/do sell, assign and transfer unto said ASSIGNEE(S), the entire right, title and interest in and to THE INVENTION and THE APPLICATION throughout the United States of America, including any and all United States Letters Patent granted on any non-provisional, division, continuation, and reissue of THE APPLICATION; and the entire right, title and interest in and to THE INVENTION throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR(S) under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all applications filed throughout the world in respect of THE INVENTION and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of THE INVENTION.

ALSO, ASSIGNOR(S) hereby agrees/agree to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of THE INVENTION or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for THE INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to THE INVENTION, all without further consideration. ASSIGNOR(S) also agrees/agree, without further consideration and at ASSIGNEE'S/ASSIGNEES' expense, to identify and communicate to ASSIGNEE(S) at ASSIGNEE'S/ASSIGNEES' request documents and information concerning THE INVENTION that are within ASSIGNOR'S/ASSIGNORS' possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE(S) that lawfully may be required of ASSIGNOR(S) in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument.

ASSIGNOR(S) also transfers to ASSIGNEE(S), without further consideration, the right to sue for past infringement of any patent claiming priority of the present application. ASSIGNOR(S) also agrees/agree, without further consideration, and at ASSIGNEE'S/ASSIGNEES' request, to provide documents and information concerning the enforcement of the right to sue within ASSIGNOR(S) possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE(S) that lawfully may be required of ASSIGNOR(S) in respect of the right to sue of any patent encompassed within the terms of this instrument.

ASSIGNOR'S/ASSIGNORS' obligation under this instrument shall extend to ASSIGNOR'S/ASSIGNORS' heirs, executors, administrators and other legal representatives.

ASSIGNOR(S) hereby grants/grant the firm of Calderon Safran & Cole P.C. of McLean, Virginia, the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

ASSIGNOR(S) hereby authorizes/authorize and requests/request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behalf; and for the use and behalf of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNORS had this assignment and sale not been made.

The parties agree that this assignment may be electronically signed. The parties agree that electronic signatures appearing on this assignment are the same as handwritten signatures for the purposes of validity, enforcement and

Date November 10. 2022 Signature of Assignor 平外间 菜完 Eiji TSUKADA

Date November 10, 2022 Signature of Assignor _ 场田 政東

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